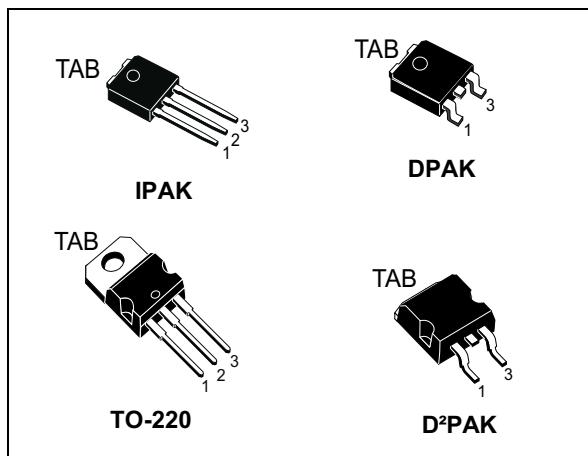


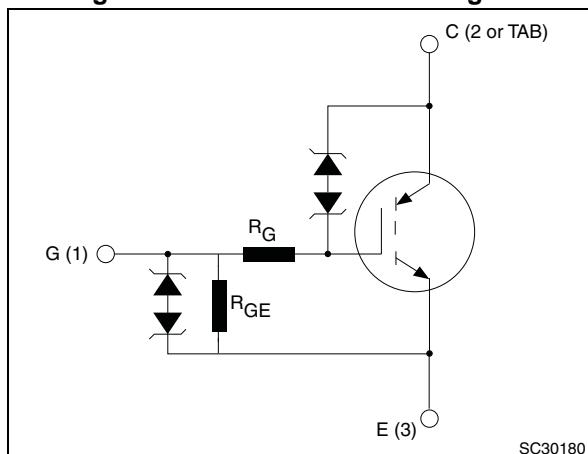
# STGB18N40LZT4, STGD18N40LZ, STGP18N40LZ

Automotive-grade 390 V internally clamped IGBT  
 $E_{SCIS}$  180 mJ

Datasheet - production data



**Figure 1. Internal schematic diagram**



## Features

- Designed for automotive applications and AEC-Q101 qualified
- 180 mJ of avalanche energy @  $T_C = 150^\circ\text{C}$ ,  $L = 3 \text{ mH}$
- ESD gate-emitter protection
- Gate-collector high voltage clamping
- Logic level gate drive
- Low saturation voltage
- High pulsed current capability
- Gate and gate-emitter resistor

## Application

- Pencil coil electronic ignition driver

## Description

This application-specific IGBT utilizes the most advanced PowerMESH™ technology. The built-in Zener diodes between gate-collector and gate-emitter provide overvoltage protection capabilities. The device also exhibits low on-state voltage drop and low threshold drive for use in automotive ignition system.

**Table 1. Device summary**

Order codes	Marking	Package	Packaging
STGB18N40LZT4	GB18N40LZ	D <sup>2</sup> PAK	Tape and reel
STGD18N40LZ-1	GD18N40LZ	IPAK	Tube
STGD18N40LZT4	GD18N40LZ	DPAK	Tape and reel
STGP18N40LZ	GP18N40LZ	TO-220	Tube

## Contents

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# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage ( $V_{GE} = 0$ )	$V_{CES(\text{clamped})}$	V
$V_{ECS}$	Emitter collector voltage ( $V_{GE} = 0$ )	20	V
$I_C^{(1)}$	Collector current (continuous) at $T_C = 100^\circ\text{C}$	30	A
$I_{CP}^{(2)}$	Pulsed collector current	40	A
$V_{GE}$	Gate-emitter voltage	$V_{GE(\text{clamped})}$	V
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	150	W
$E_{SCIS}^{(3)}$	Single pulse energy $T_C = 25^\circ\text{C}$ , $L = 3 \text{ mH}$ , $V_{CC} = 50 \text{ V}$	300	mJ
	Single pulse energy $T_C = 150^\circ\text{C}$ , $L = 3 \text{ mH}$ , $V_{CC} = 50 \text{ V}$	180	mJ
ESD	Human body model, $R = 1.5 \text{ k}\Omega$ , $C = 100 \text{ pF}$	8	kV
	Machine model, $R = 0$ , $C = 100 \text{ pF}$	800	V
	Charged device model	2	kV
$T_{stg}$	Storage temperature	– 55 to 175	$^\circ\text{C}$
$T_j$	Operating junction temperature		

1. Calculated according to the iterative formula

$$I_C(T_C) = \frac{T_{j(\max)} - T_C}{R_{thj-c} \times V_{CE(sat)(\max)}(T_{j(\max)}, I_C(T_C))}$$

2. Pulse width limited by max. junction temperature
3. For  $E_{SCIS}$  test circuit refer to [Figure 16.: Inductive load switching and  \$E\_{SCIS}\$  test circuit](#) with A and B not connected.

Table 3. Thermal data

Symbol	Parameter	Value		Unit
		DPAK IPAK	D <sup>2</sup> PAK TO-220	
$R_{thj-case}$	Thermal resistance junction-case	1		$^\circ\text{C/W}$
$R_{thj-amb}$	Thermal resistance junction-ambient	100	62.5	$^\circ\text{C/W}$

## 2 Electrical characteristics

( $T_J=25\text{ }^{\circ}\text{C}$  unless otherwise specified)

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{CES(\text{clamped})}$	Collector emitter clamped voltage ( $V_{GE} = 0$ )	$I_C = 2\text{ mA}$ $T_J = -40\text{ }^{\circ}\text{C to } 150\text{ }^{\circ}\text{C}$	360	390	420	V
$V_{(BR)ECS}$	Emitter collector break-down voltage ( $V_{GE} = 0$ )	$I_C = 75\text{ mA}$	20	28		V
$V_{GE(\text{clamped})}$	Gate emitter clamped voltage	$I_G = \pm 2\text{ mA}$	12		16	V
$I_{CES}$	Collector cut-off current ( $V_{GE} = 0$ )	$V_{CE} = 15\text{ V}, T_J = 150\text{ }^{\circ}\text{C}$			10	$\mu\text{A}$
		$V_{CE} = 200\text{ V}, T_J = 150\text{ }^{\circ}\text{C}$			100	$\mu\text{A}$
$I_{GES}$	Gate-emitter leakage current ( $V_{CE} = 0$ )	$V_{GE} = \pm 10\text{ V}$	450	625	830	$\mu\text{A}$
$R_{GE}$	Gate emitter resistance		12	16	22	$\text{k}\Omega$
$R_G$	Gate resistance			1.6		$\text{k}\Omega$
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{GE} = V_{CE}, I_C = 1\text{ mA}, T_J = -40\text{ }^{\circ}\text{C}$	1.4			V
		$V_{GE} = V_{CE}, I_C = 1\text{ mA}$	1.2	1.6	2.3	V
		$V_{GE} = V_{CE}, I_C = 1\text{ mA}, T_J = 150\text{ }^{\circ}\text{C}$	0.7			V
$V_{CE(\text{sat})}$	Collector emitter saturation voltage	$V_{GE} = 4.5\text{ V}, I_C = 10\text{ A}$		1.35	1.7	V
		$V_{GE} = 4.5\text{ V}, I_C = 10\text{ A}, T_J = 150\text{ }^{\circ}\text{C}$		1.30		V
		$V_{GE} = 3.8\text{ V}, I_C = 6\text{ A}$		1.30		V

**Table 5. Dynamic electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{ies}$	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz}, V_{GE} = 0$	-	490	-	pF
$C_{oes}$	Output capacitance		-	90	-	pF
$C_{res}$	Reverse transfer capacitance		-	5	-	pF
$Q_g$	Gate charge	$V_{CE} = 280\text{ V}, I_C = 10\text{ A}, V_{GE} = 5\text{ V}$	-	29	-	nC

**Table 6. Resistive load switching time**

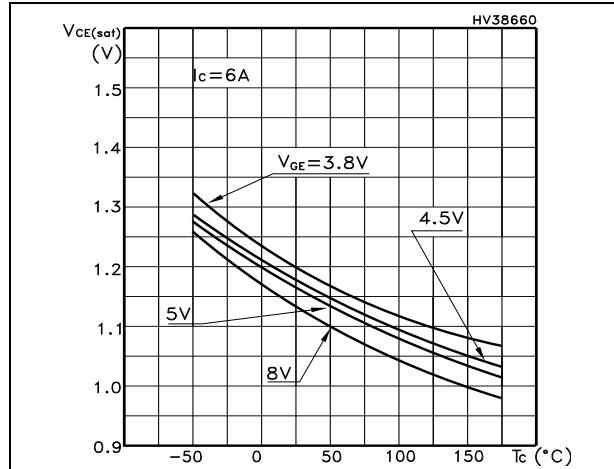
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 14 \text{ V}$ , $R_L = 1 \Omega$ , $V_{GE} = 5 \text{ V}$	-	0.65	-	$\mu\text{s}$
$t_r$	Rise time		-	3.5	-	$\mu\text{s}$
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 14 \text{ V}$ , $R_L = 1 \Omega$ , $V_{GE} = 5 \text{ V}$ , $T_J = 150 \text{ }^\circ\text{C}$	-	0.65	-	$\mu\text{s}$
$t_r$	Rise time		-	3.8	-	$\mu\text{s}$

**Table 7. Inductive load switching time**

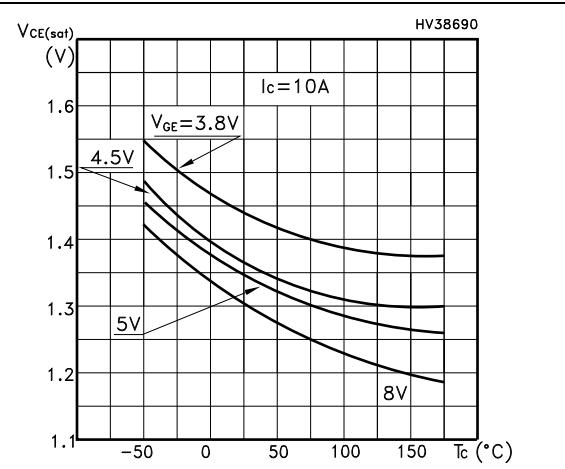
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$	Turn-off delay time	$V_{CC} = 300 \text{ V}$ , $L = 1 \text{ mH}$ $I_C = 10 \text{ A}$ , $V_{GE} = 5 \text{ V}$	-	13.5	-	$\mu\text{s}$
$t_f$	Fall time		-	5.5	-	$\mu\text{s}$
$dv/dt$	Turn-off voltage slope		-	105	-	$\text{V}/\mu\text{s}$
$t_{d(off)}$	Turn-off delay time	$V_{CC} = 300 \text{ V}$ , $L = 1 \text{ mH}$ $I_C = 10 \text{ A}$ , $V_{GE} = 5 \text{ V}$ $T_J = 150 \text{ }^\circ\text{C}$	-	14.2	-	$\mu\text{s}$
$t_f$	Fall time		-	8	-	$\mu\text{s}$
$dv/dt$	Turn-off voltage slope		-	97	-	$\text{V}/\mu\text{s}$

## 2.1 Electrical characteristics (curves)

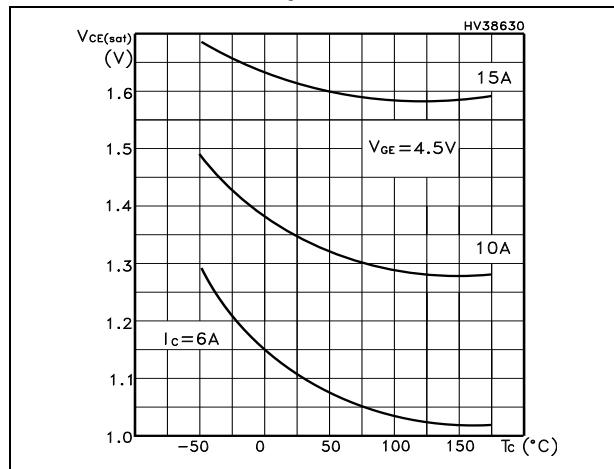
**Figure 2. Collector-emitter on voltage vs temperature**



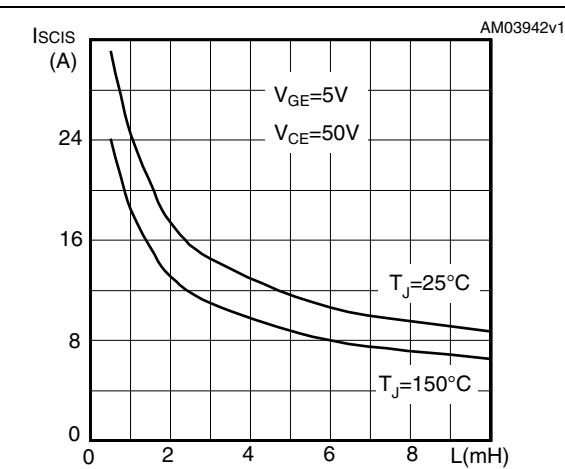
**Figure 3. Collector-emitter on voltage vs temperature**

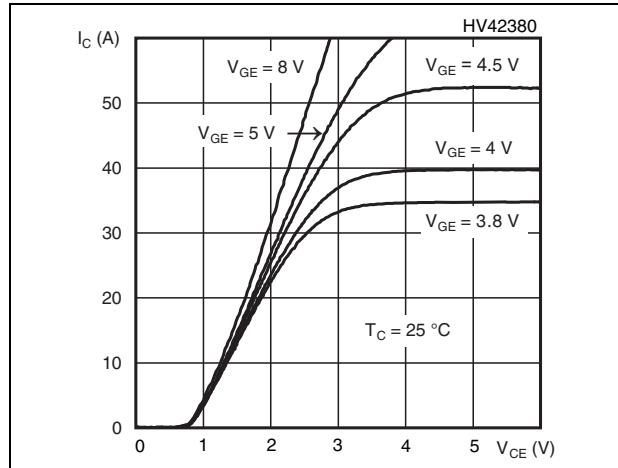
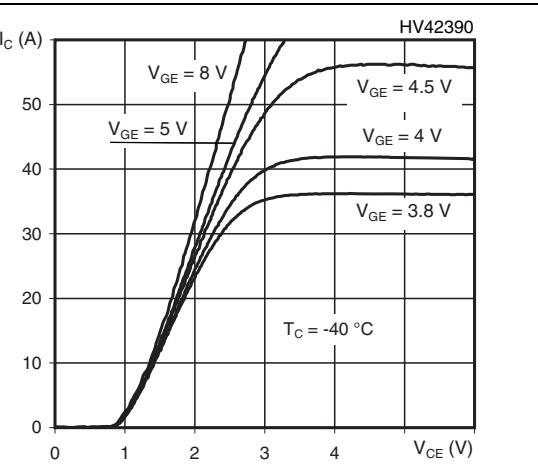
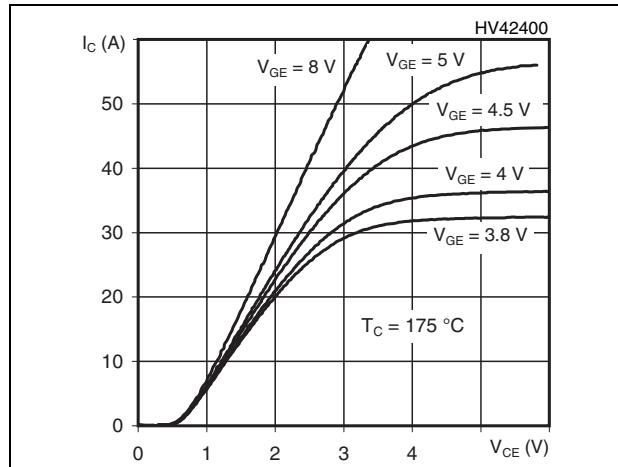
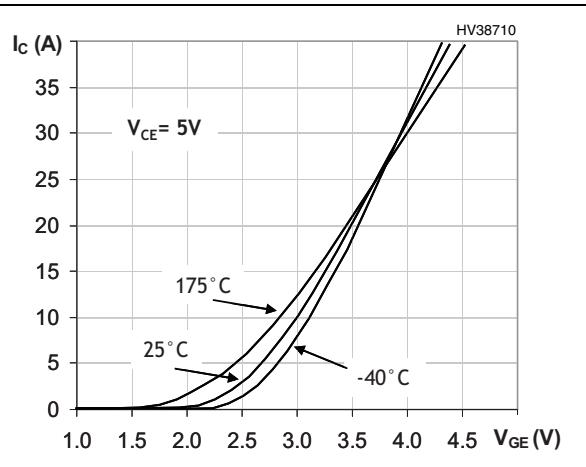
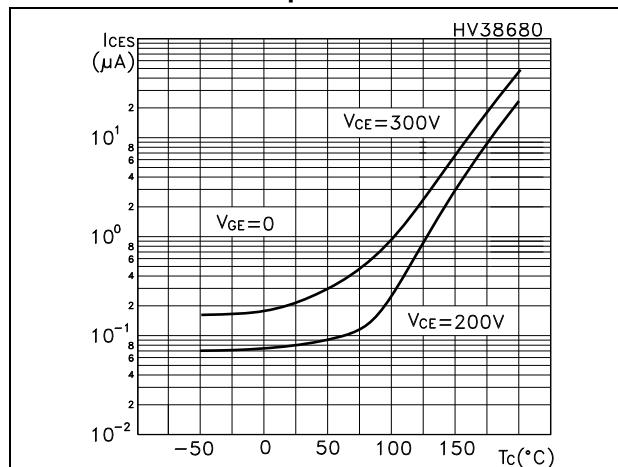
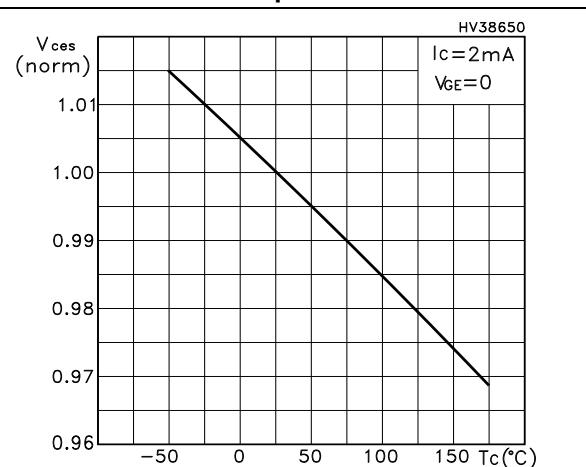


**Figure 4. Collector-emitter on voltage vs temperature**

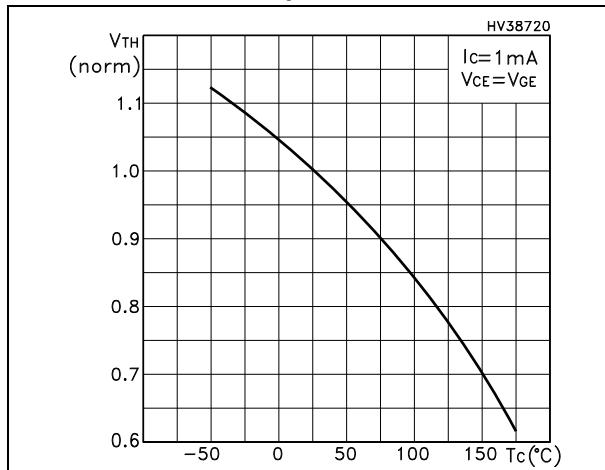


**Figure 5. Self clamped inductive switch**

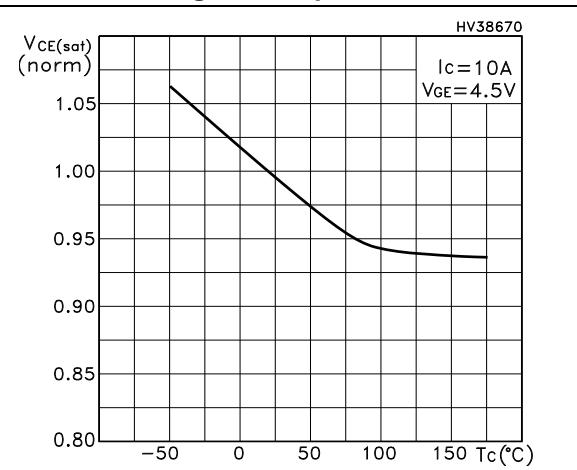


**Figure 6. Output characteristics @ 25 °C****Figure 7. Output characteristics @ -40 °C****Figure 8. Output characteristics @ 175 °C****Figure 9. Transfer characteristics****Figure 10. Collector cut-off current vs. temperature****Figure 11. Normalized collector emitter voltage vs temperature**

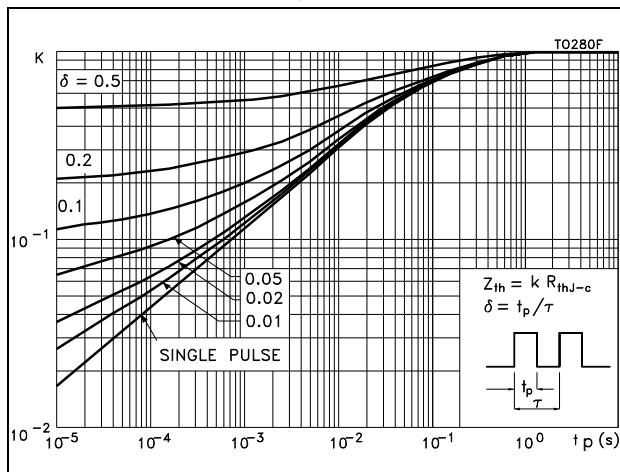
**Figure 12. Normalized gate threshold voltage vs temperature**



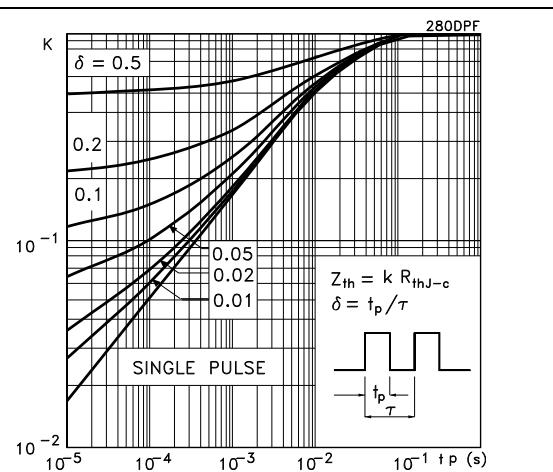
**Figure 13. Normalized collector emitter on voltage vs temperature**



**Figure 14. Thermal impedance for D<sup>2</sup>PAK, I<sup>2</sup>PAK, TO-220**

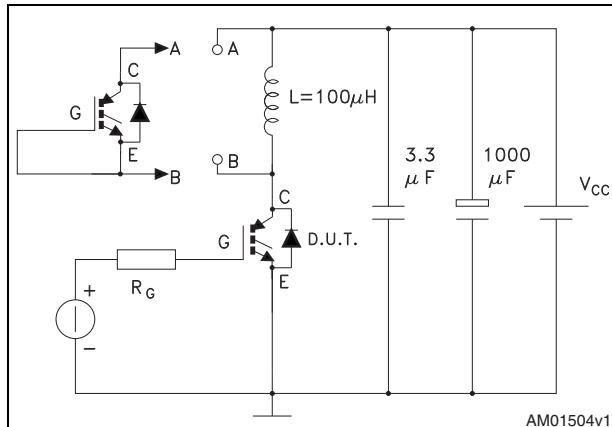


**Figure 15. Thermal impedance for DPAK, IPAK**

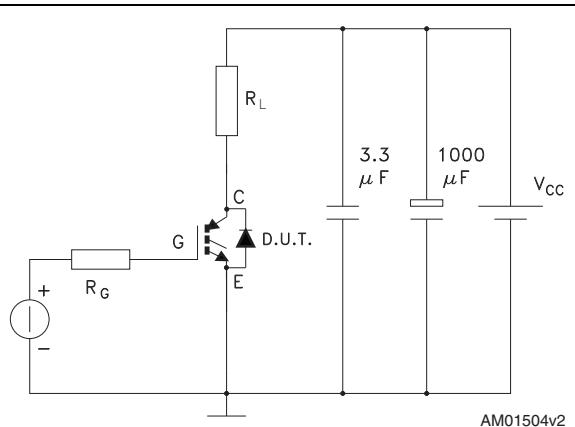


### 3 Test circuits

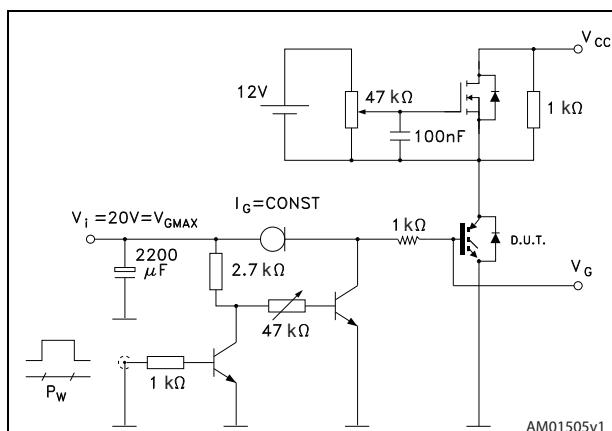
**Figure 16. Inductive load switching and  $E_{SCIS}$  test circuit**



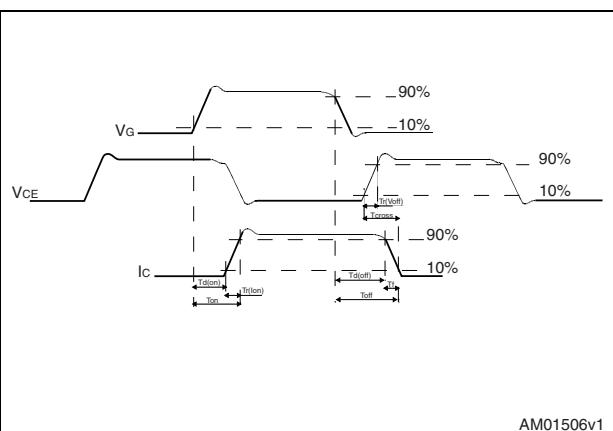
**Figure 17. Resistive load switching**



**Figure 18. Gate charge test circuit**



**Figure 19. Switching waveform**

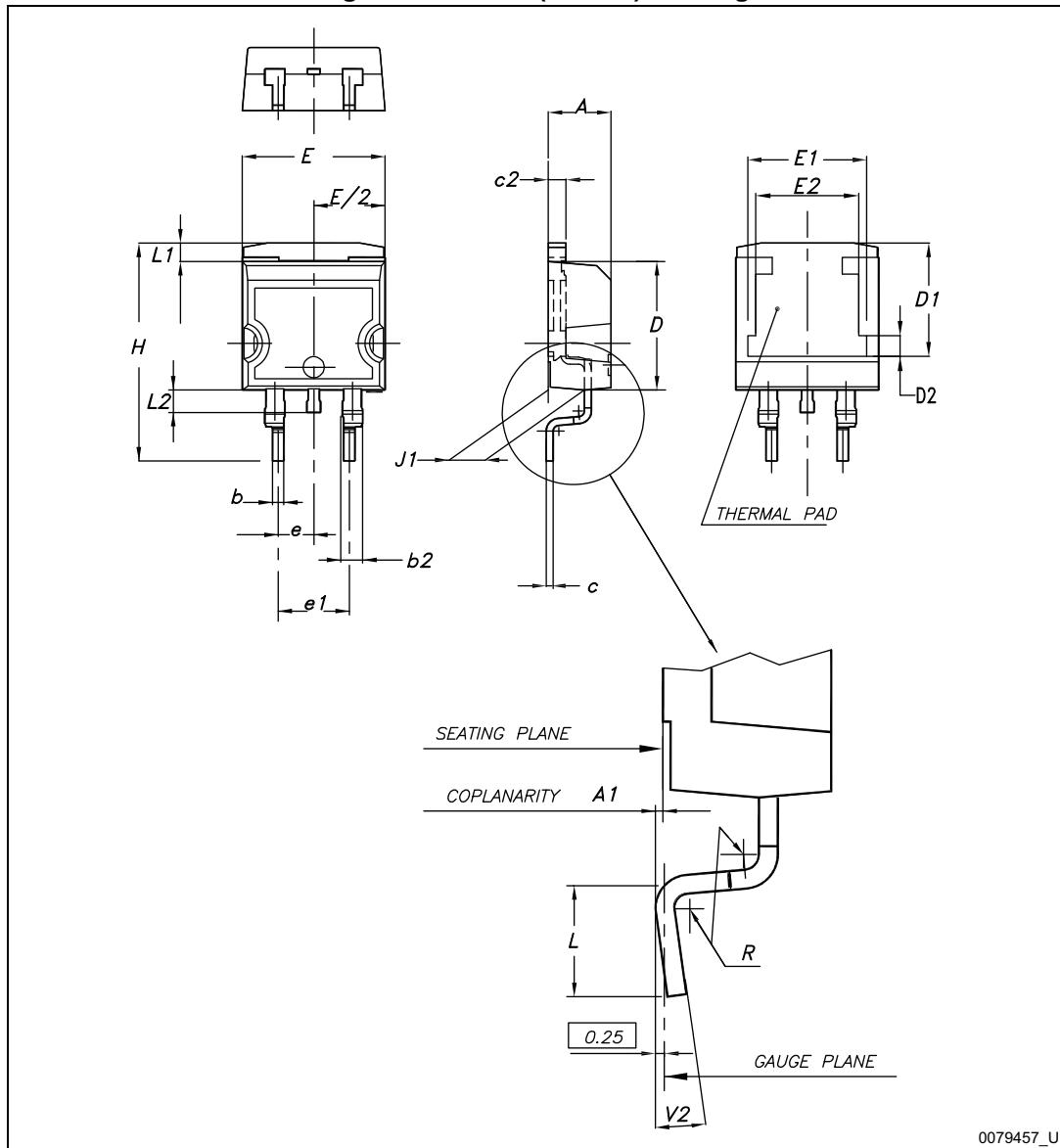


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK is an ST trademark.

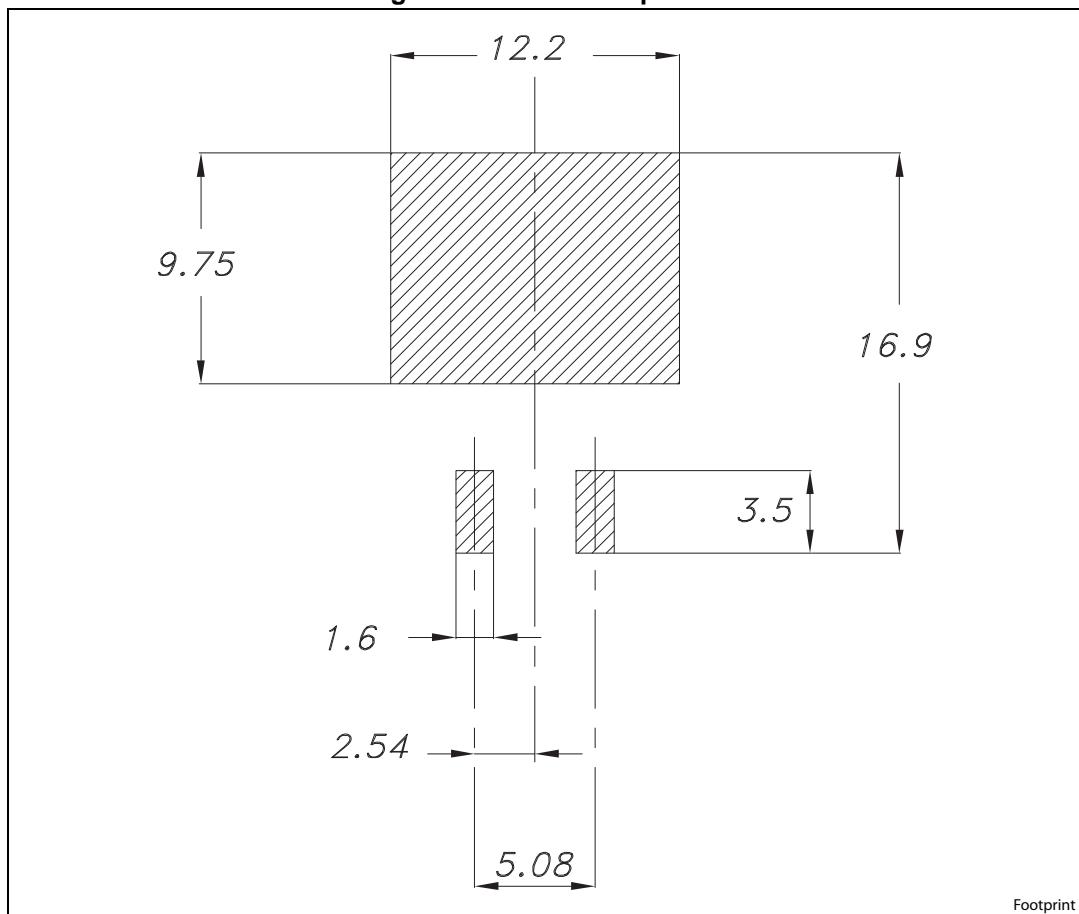
## 4.1 STGB18N40LZT4, D<sup>2</sup>PAK

Figure 20. D<sup>2</sup>PAK (TO-263) drawing



**Table 8. D<sup>2</sup>PAK (TO-263) mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10		10.40
E1	8.50	8.70	8.90
E2	6.85	7.05	7.25
e		2.54	
e1	4.88		5.28
H	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

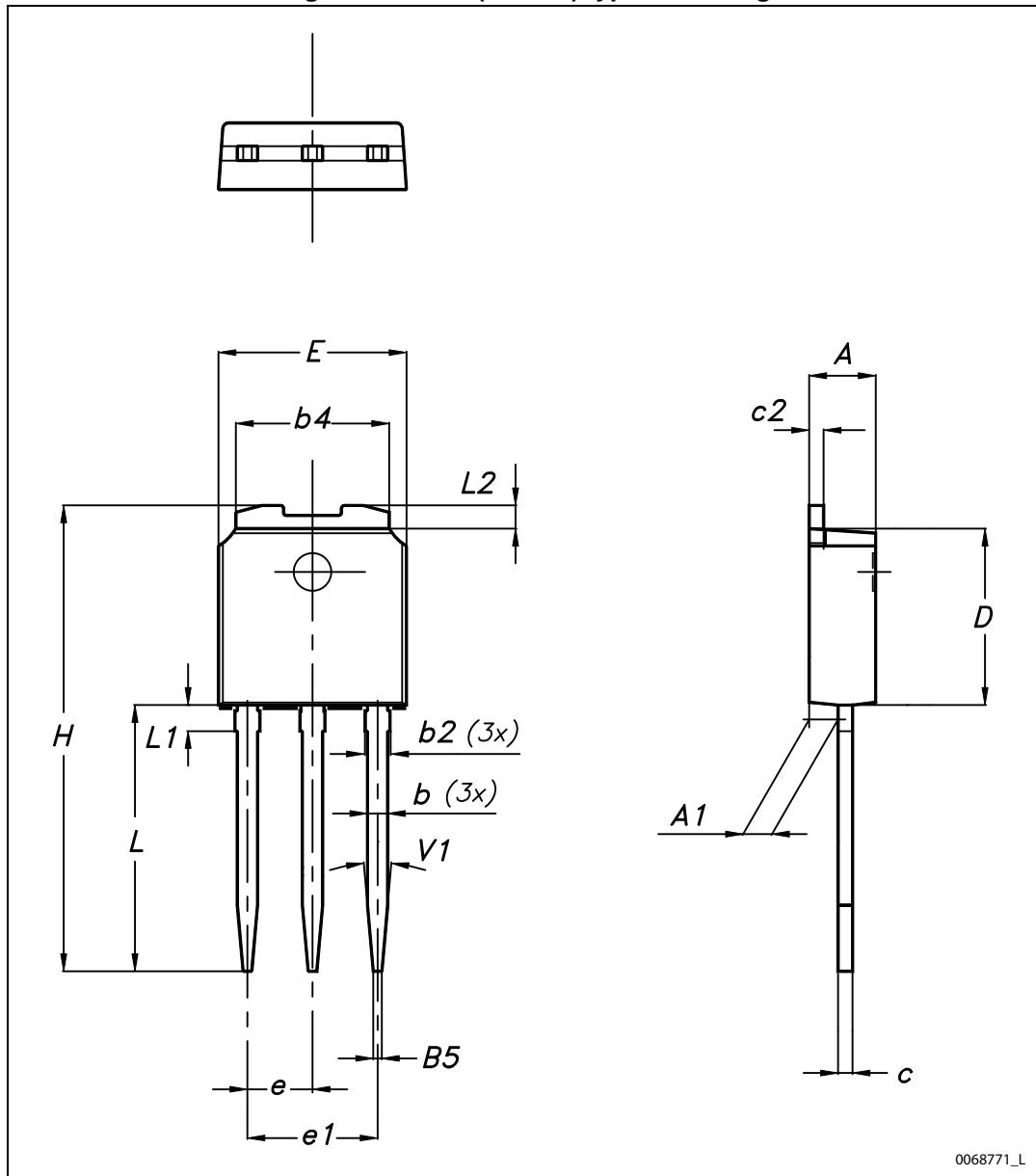
**Figure 21. D<sup>2</sup>PAK footprint<sup>(a)</sup>**

Footprint

a. All dimension are in millimeters

## 4.2 STGD18N40LZ-1, IPAK

Figure 22. IPAK (TO-251) type A drawing

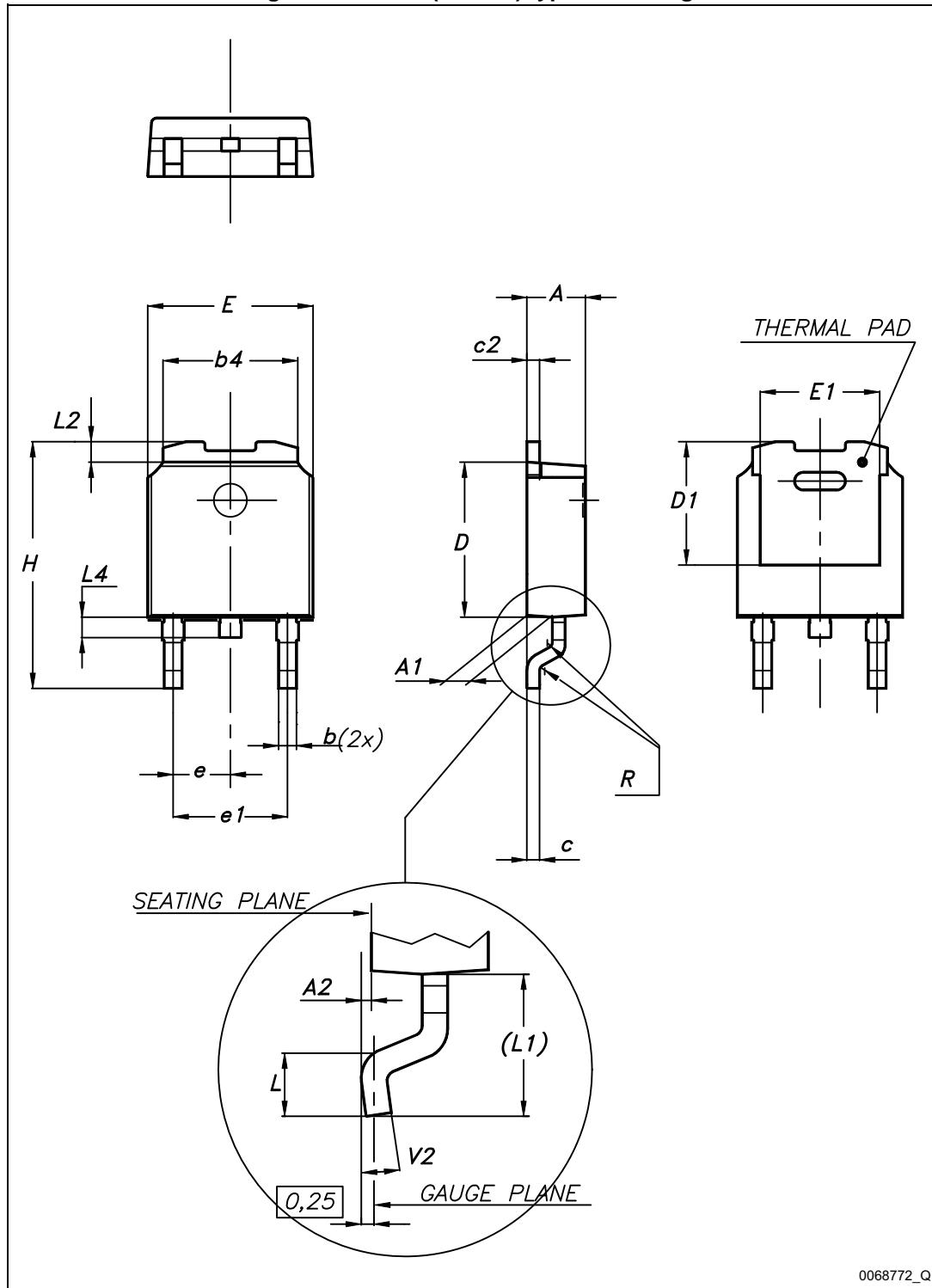


**Table 9. IPAK (TO-251) type A mechanical data**

DIM	mm.		
	min.	typ.	max.
A	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.30	
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
E	6.40		6.60
e		2.28	
e1	4.40		4.60
H		16.10	
L	9.00		9.40
L1	0.80		1.20
L2		0.80	1.00
V1		10°	

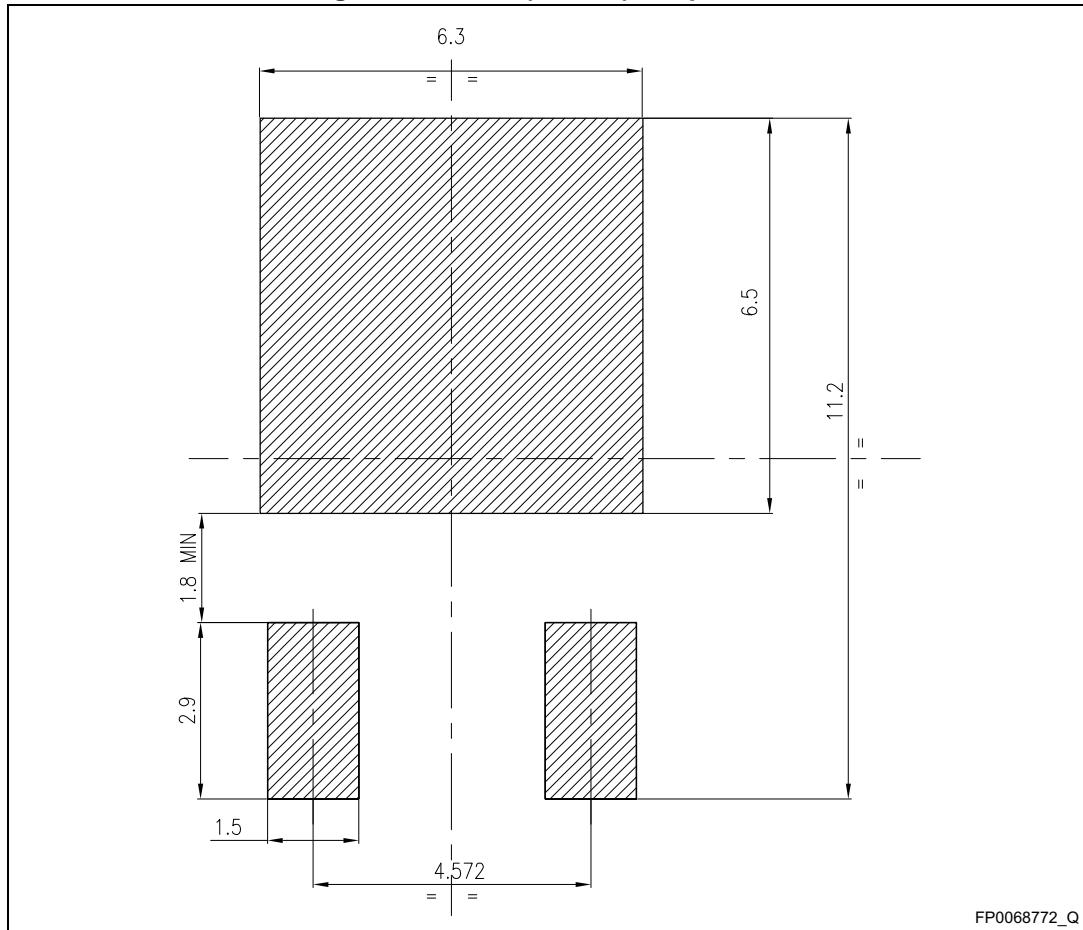
### 4.3 STGD18N40LZT4, DPAK

Figure 23. DPAK (TO-252) type A drawing



**Table 10. DPAK (TO-252) type A mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
e		2.28	
e1	4.40		4.60
H	9.35		10.10
L	1.00		1.50
L1		2.80	
L2		0.80	
L4	0.60		1.00
R		0.20	
V2	0°		8°

**Figure 24. DPAK (TO-252) footprint <sup>(b)</sup>**

b. All dimensions are in millimeters

## 4.4 STGP18N40LZ, TO-220

Figure 25. TO-220 type A drawing

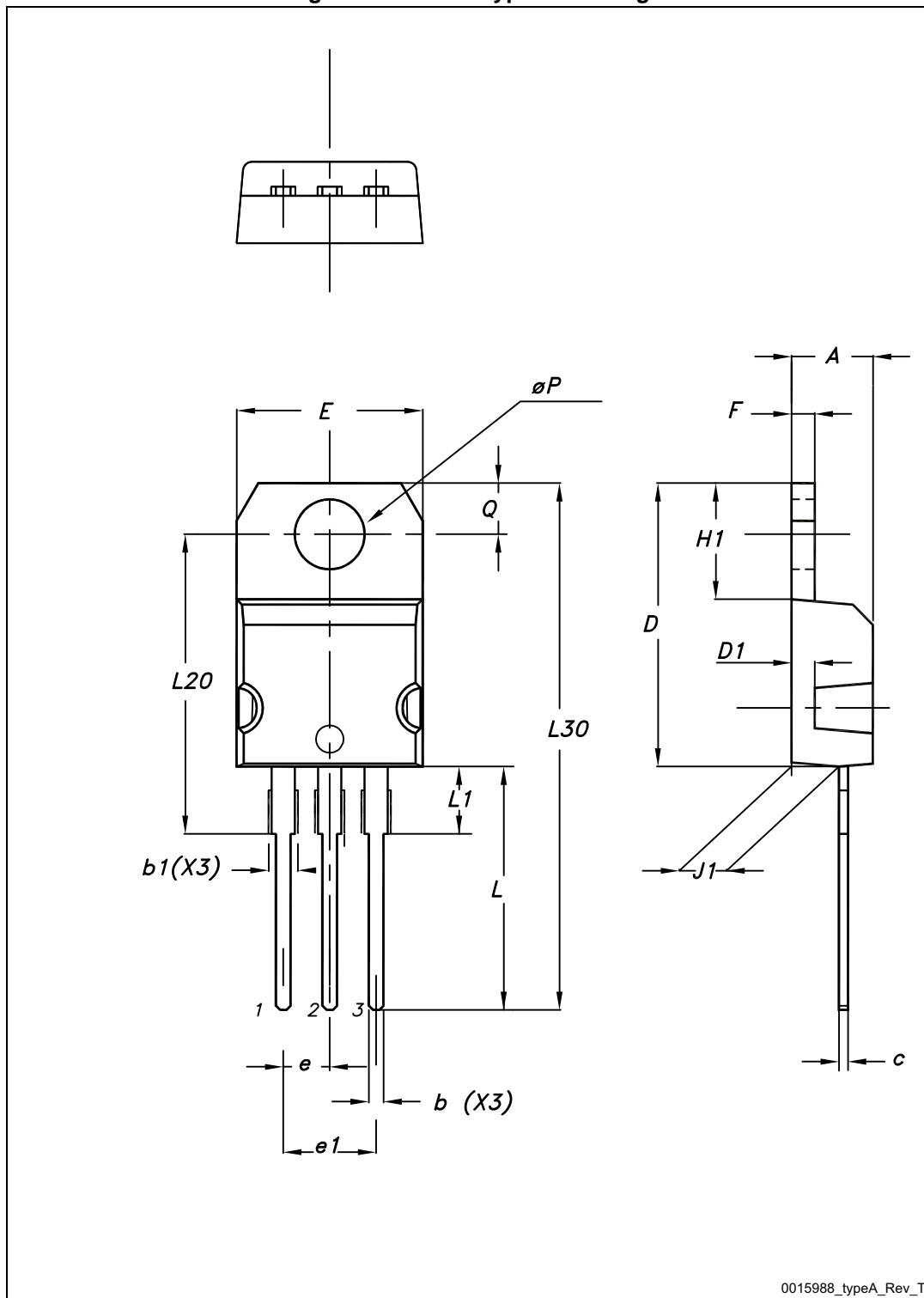


Table 11. TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

## 5 Packaging mechanical data

**Figure 26. Tape for DPAK and D<sup>2</sup>PAK**

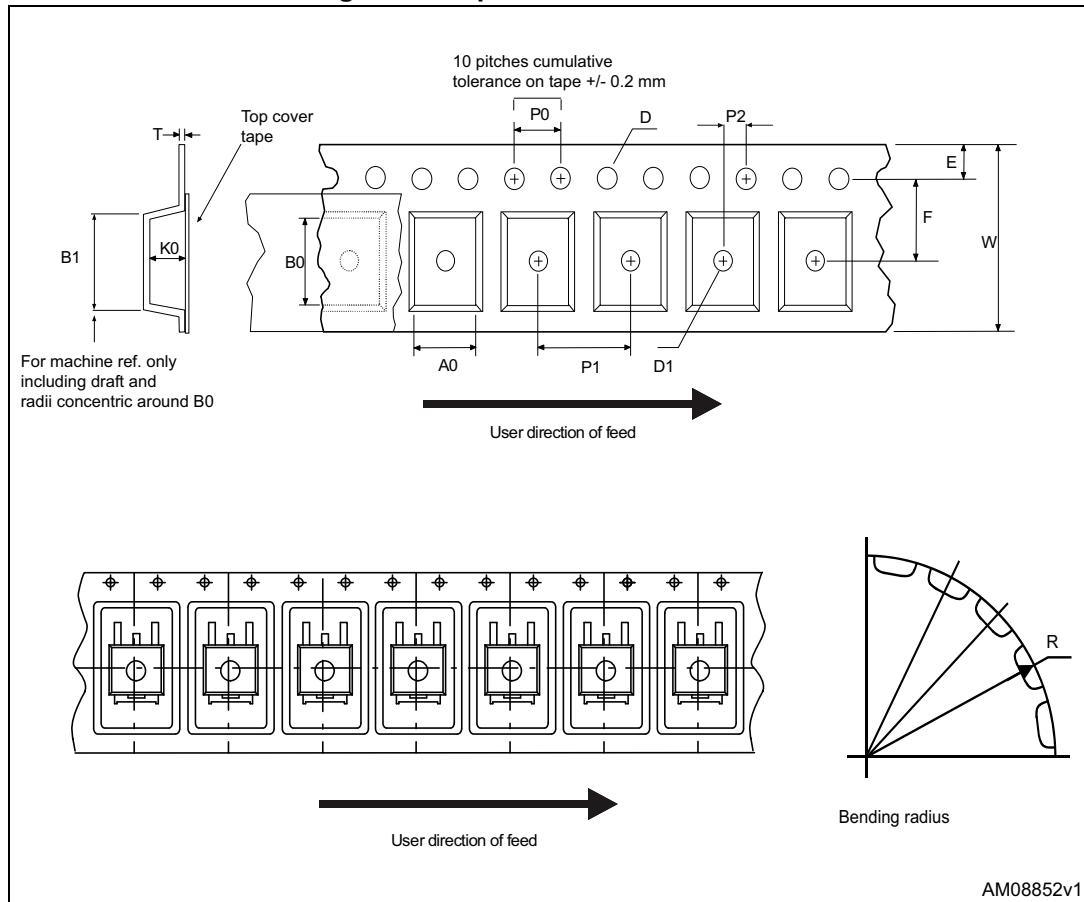


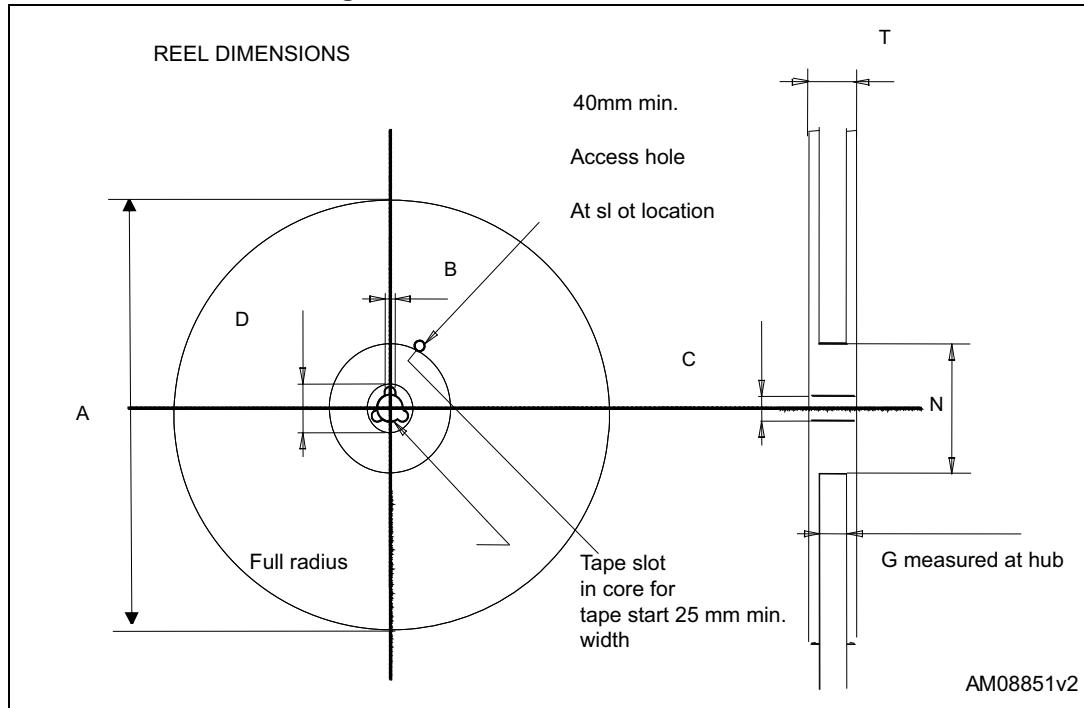
Figure 27. Reel for DPAK and D<sup>2</sup>PAK

Table 12. DPAK (TO-252) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	B	1.5	
B1		12.1	C	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	T		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
T	0.25	0.35			
W	15.7	16.3			

**Table 13. D<sup>2</sup>PAK (TO-263) tape and reel mechanical data**

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1		Base qty	1000
P2	1.9	2.1		Bulk qty	1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

## 6 Revision history

Table 14. Document revision history

Date	Revision	Changes
18-Jan-2008	1	Initial release.
07-Mar-2008	2	Modified <a href="#">Figure 7</a> , <a href="#">Figure 8</a> , <a href="#">Figure 10</a> .
07-May-2008	3	Modified <a href="#">Figure 9</a>
31-Mar-2009	4	Added new package, mechanical data: TO-220
18-May-2009	5	Modified <a href="#">Figure 5</a>
12-Nov-2014	6	Updated <a href="#">Table 1: Device summary</a> , <a href="#">Table 2: Absolute maximum ratings</a> and <a href="#">Table 3: Thermal data</a> Updated <a href="#">3: Test circuits</a> Updated <a href="#">Section 4: Package mechanical data</a> Updated <a href="#">Section 5: Packaging mechanical data</a> Minor text changes

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